

Notice of References Cited		Application/Control No. 10/535,026	Applicant(s)/Patent Under Reexamination BHATTACHARYA ET AL.	
		Examiner EDNA WONG	Art Unit 1795	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
*	A	US-5,741,377	04-1998	Goyal et al.	148/512
*	B	US-5,873,992	02-1999	Glezen et al.	205/159
*	C	US-6,465,376	10-2002	Uzoh et al.	438/627
	D	US-			
	E	US-			
	F	US-			
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	T					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)			
*	U	Diaz et al., "Preparation of Biaxially Cube Textured Ag, Cu-Au and Cu-Au-Ag Films on Cu Substrates for HTS Coated Conductor Applications", Supercond. Sci. Technol., Vol. 14 (no month, 2001), pp. 576-582.			
*	V	Hirai et al., "Growth of Gold Plating Film on Various Nickel Substrates", Hyomen Gijutsu (no month, 1992), Vol. 43, No. 9, pp. 868-872.			
	W	Nikolova, "Structure of Gold Coatings and Gold Electrodeposition Processes From Cyanide-Free Electrolytes. II. Effect of the Substrate and Dependence of the Texture to Coating Formation", Izvestiya po Khimiya (no month, 1977), Vol. 10, No. 3, pp. 345-60). ABSTRACT ONLY (1 page).			
	X				

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.